



	CPC1150N	Units
Load Voltage	350	V
Load Current	100	mA
Max R_{ON}	50	Ω

Features

- Small 4 Pin SOP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 1500V_{RMS} Input/Output Isolation
- FCC Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - Dial Pulsing
 - Ground Start
 - Ringer Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1150N is a miniature 1-Form-B solid state relay which uses optically coupled MOSFET technology to provide 1500V of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture. The optically-coupled input is controlled by a highly efficient GaAlAs infrared LED. The CPC1150N uses Clare's state of the art double molded vertical construction packaging to produce the world's smallest 4 pin SOP package. The CPC1150N offers board space savings of at least 20% over the competitor's larger 4 Pin SOP relay.

Approvals

- UL / C-UL Recognized Component: File #E76270
- BSI Certified - Certificate #: 8416

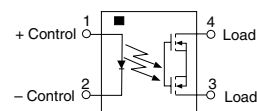
Ordering Information

Part #	Description
CPC1150N	4 Pin SOP (100/tube)
CPC1150NTR	4 Pin SOP (2,000/reel)

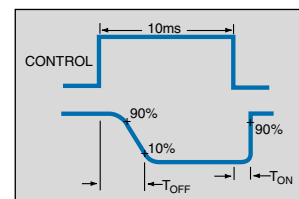
* For other packaging options, consult factory.

Pin Configuration

CPC1150N Pinout



Switching Characteristics of Normally Closed (Form B) Devices



**Absolute Maximum Ratings (@ 25° C)**

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	400 ¹	mW
Isolation Voltage Input to Output	1500	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature (10 Seconds Max.)	-	-	+220	°C

¹ Derate Linearly 3.33 mw / °C

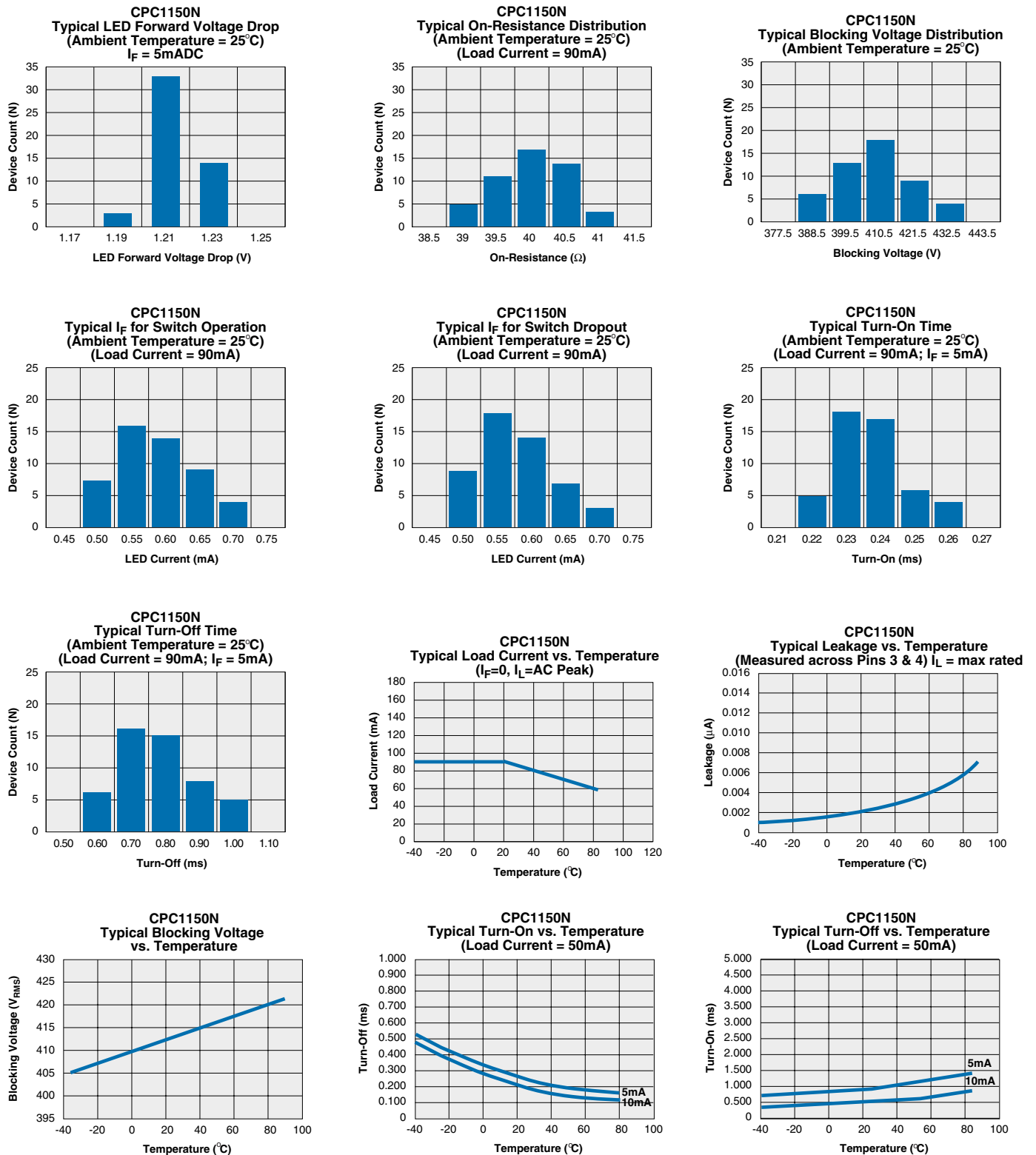
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

Electrical Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Voltage (Peak)	-	V _L	-	-	350	V
Load Current (Continuous) AC Peak ¹		I _L	-	-	120	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance	I _L =90mA	R _{ON}	-	-	50	Ω
Off-State Leakage Current	V _L =350V, I _F =2mA	I _{LEAK}	-	-	5	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	1.0	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	2	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	-	pF
Capacitance Input to Output	-	-	-	1	-	pF
Input Characteristics @ 25°C						
Input Control Current ²	I _L =90mA	I _F	2	-	50	mA
Input Dropout Current	-	I _F	0.3	0.9	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA

¹ Load current derates linearly from 90mA @ 25°C to 70mA @ 85°C.

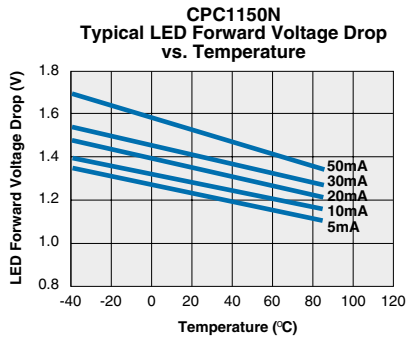
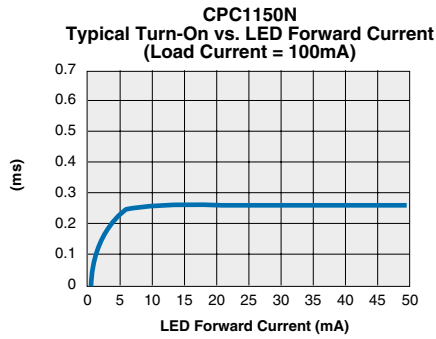
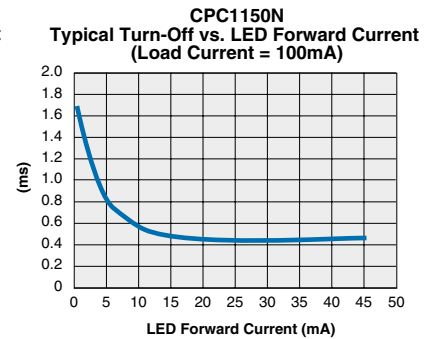
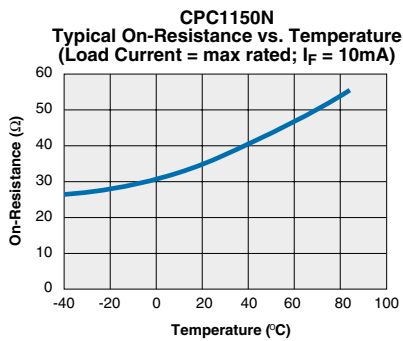
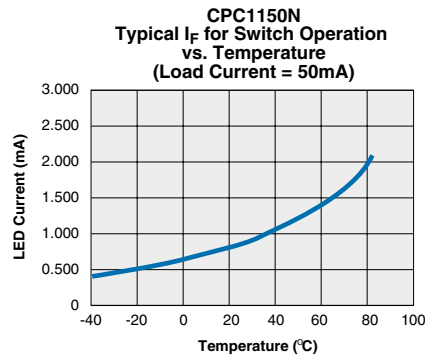
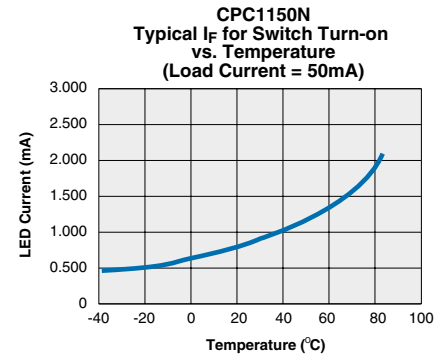
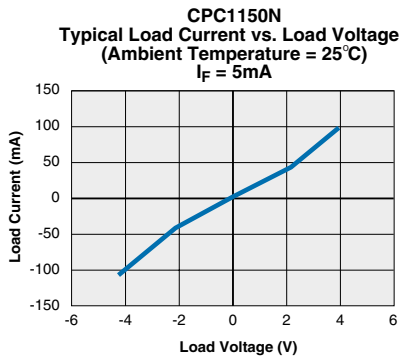
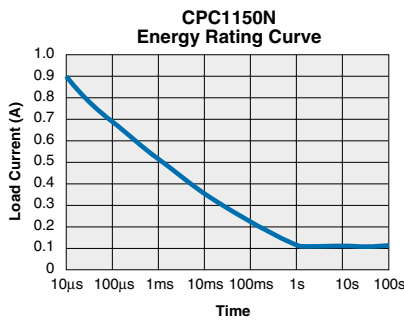
² For applications requiring high temperature operation (greater than 60°C) an LED drive current of 10mA is recommended.

PERFORMANCE DATA*


*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



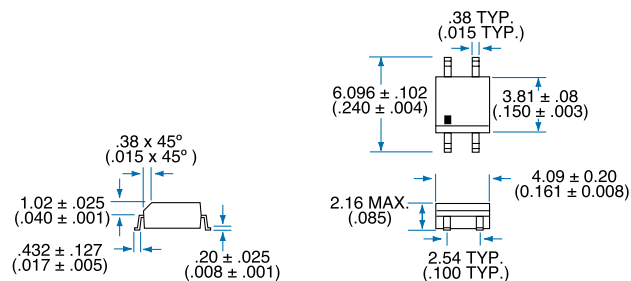
PERFORMANCE DATA*



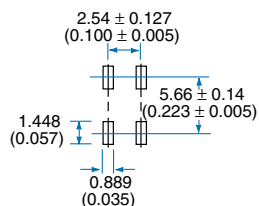
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MECHANICAL DIMENSIONS

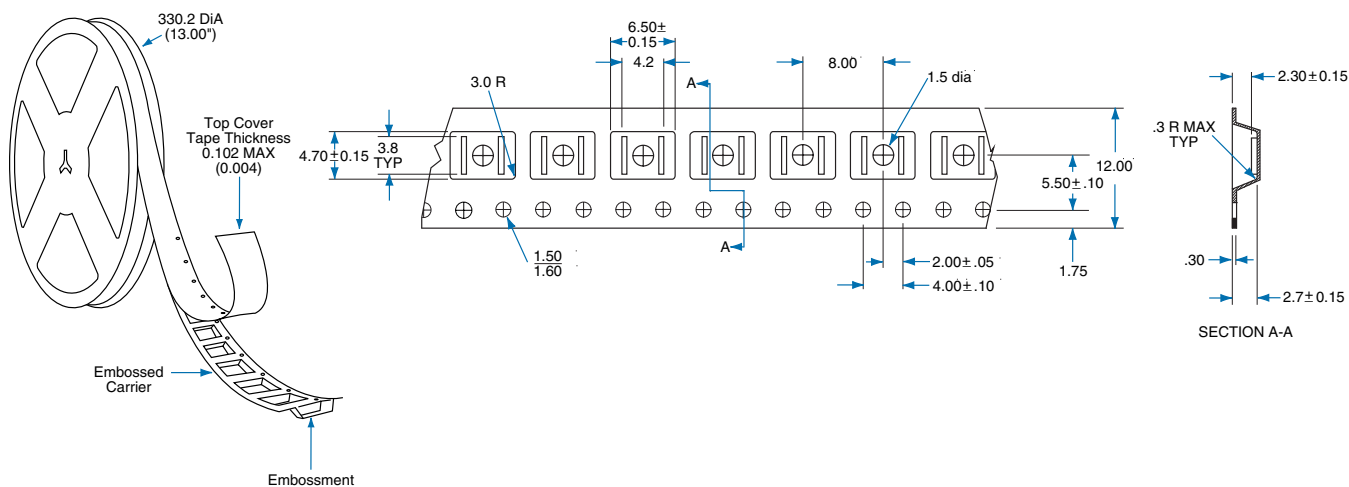
4 Pin SOIC Narrow ("N" Suffix)



PC Board Pattern (Top View)



Tape and Reel Packaging for 4 pin SOIC package



Dimensions
mm
(inches)



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